# 506512035 02/18/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT6558810 Stylesheet Version v1.2

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
SHIGEKI ISHIGURO	02/08/2021
KAYO SHIMOKAWA	02/08/2021
TETSUYA OTSUKA	02/09/2021
HIDETOSHI MAIKAWA	02/09/2021

## **RECEIVING PARTY DATA**

Name:	NITTO DENKO CORPORATION	
Street Address:	1-1-2, SHIMOHOZUMI	
City:	IBARAKI-SHI, OSAKA	
State/Country:	JAPAN	
Postal Code:	567-8680	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17269452

## **CORRESPONDENCE DATA**

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 6417-0015

 NAME OF SUBMITTER:
 YOON S. HAM

 SIGNATURE:
 /Yoon S. Ham/

 DATE SIGNED:
 02/18/2021

**Total Attachments: 1** 

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PATENT REEL: 055323 FRAME: 0244

506512035

#### Docket No.:

## ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Shigeki ISHIGURO
- Kayo SHIMOKAWA
- 3) Tetsuva OTSUKA
- Hidetoshi MAIKAWA
- П x box if continued on page 2

who has made a certain new and useful invention, hereby sells, assigns and transfers to Nitto Denko Corporation having a place of business at 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680 [APAN its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled:

#### LAMINATED SHEET

- for which an application for United States Letters Patent was filed on \_\_\_\_\_\_, and identified by United (a) States Patent Application No. \_\_\_\_\_; or
- for which an application for United States Letters Patent was executed on (b)

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE:

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Shigeki Ishiguro
Name: Shigeki ISHIGURO

3) Tetsuya OTSUKA
Name: Tetsuya OTSUKA

4) Hidetoshi MAZKAWA

Name: Hidetoshi MAIKAWA

Fab. /8/2021

Feb , 8, 202

Feb. 9, 2021

Feb. 9, 202)

Date

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